

## The RF Line

### NPN Silicon

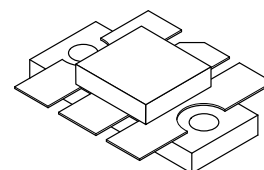
### RF Power Transistor

... designed primarily for wideband large-signal output and driver amplifier stages in the 100 to 500 MHz frequency range.

- Specified 28 Volt, 400 MHz Characteristics —  
Output Power = 100 Watts  
Minimum Gain = 7.0 dB  
Efficiency = 50% (Min)
- Built-In Matching Network for Broadband Operation Using Double Match Technique
- 100% Tested for Load Mismatch at all Phase Angles with 3:1 VSWR
- Gold Metallization System for High Reliability

**MRF329**

**100 W, 100 to 500 MHz  
CONTROLLED "Q"  
BROADBAND RF POWER  
TRANSISTOR  
NPN SILICON**



**CASE 333-04, STYLE 1**

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	30	Vdc
Collector-Base Voltage	$V_{CBO}$	60	Vdc
Emitter-Base Voltage	$V_{EBO}$	4.0	Vdc
Collector Current — Continuous — Peak	$I_C$	9.0 12	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ (1) Derate above $25^\circ\text{C}$	$P_D$	270 1.54	Watts W/ $^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-65 to +150	$^\circ\text{C}$

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (2)	$R_{\theta JC}$	0.65	$^\circ\text{C}/\text{W}$

#### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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#### OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ( $I_C = 80 \text{ mAdc}$ , $I_B = 0$ )	$V_{(BR)CEO}$	30	—	—	Vdc
Collector-Emitter Breakdown Voltage ( $I_C = 80 \text{ mAdc}$ , $V_{BE} = 0$ )	$V_{(BR)CES}$	60	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 8.0 \text{ mAdc}$ , $I_C = 0$ )	$V_{(BR)EBO}$	4.0	—	—	Vdc

#### NOTES:

(continued)

- This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.
- Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.



# **ELECTRICAL CHARACTERISTICS — continued** ( $T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS (continued)</b>					
Collector–Base Breakdown Voltage ( $I_C = 80\text{ mA}$ , $I_E = 0$ )	$V_{(BR)CBO}$	60	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 30\text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	—	—	5.0	mA

## **ON CHARACTERISTICS**

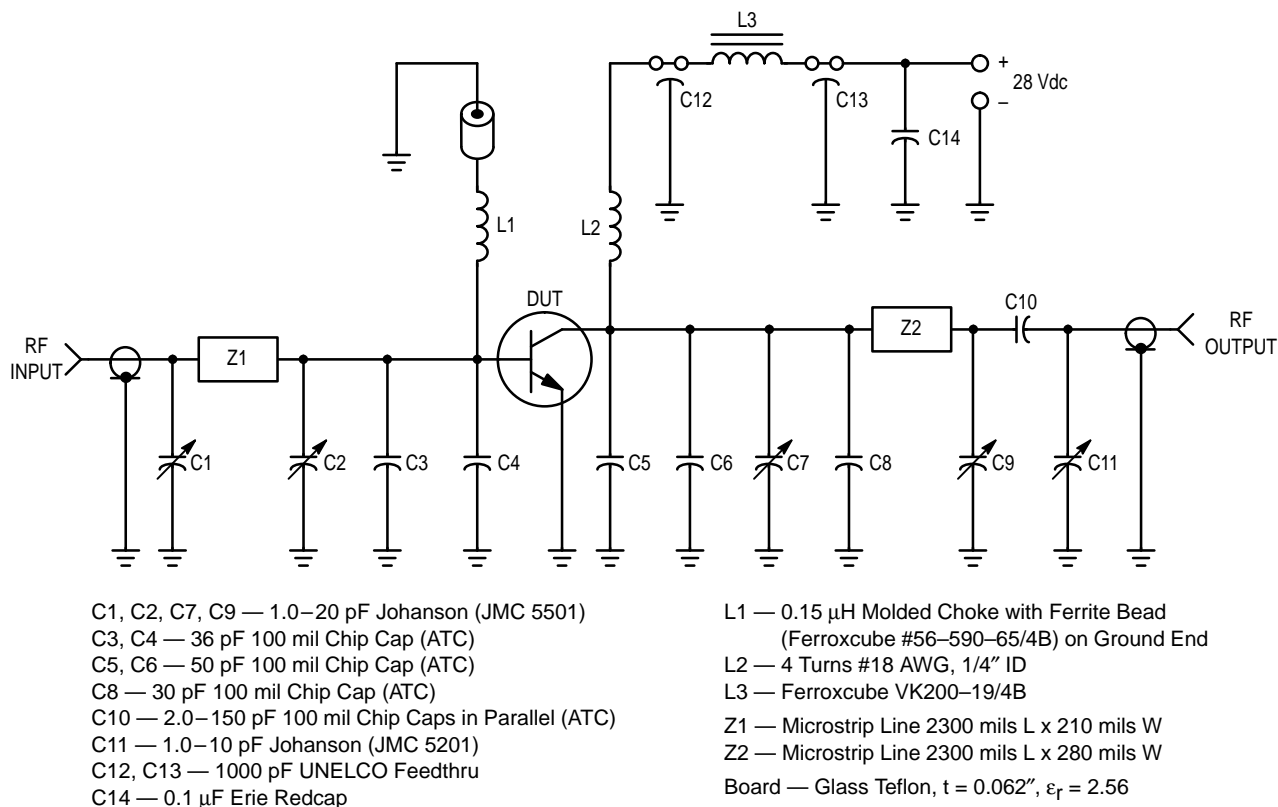
DC Current Gain ( $I_C = 4.0\text{ A}$ , $V_{CE} = 5.0\text{ Vdc}$ )	$h_{FE}$	20	—	80	—
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## **DYNAMIC CHARACTERISTICS**

Output Capacitance ( $V_{CB} = 28\text{ Vdc}$ , $I_E = 0$ , $f = 1.0\text{ MHz}$ )	$C_{ob}$	—	95	125	pF
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## **FUNCTIONAL TESTS (Figure 1)**

Common–Emitter Amplifier Power Gain ( $V_{CC} = 28\text{ Vdc}$ , $P_{out} = 100\text{ W}$ , $f = 400\text{ MHz}$ )	$G_{PE}$	7.0	9.7	—	dB
Collector Efficiency ( $V_{CC} = 28\text{ Vdc}$ , $P_{out} = 100\text{ W}$ , $f = 400\text{ MHz}$ )	$\eta$	50	60	—	%
Load Mismatch ( $V_{CC} = 28\text{ Vdc}$ , $P_{out} = 100\text{ W}$ , $f = 400\text{ MHz}$ , VSWR = 3:1 all angles)	$\psi$	No Degradation in Output Power			



**Figure 1. 400 MHz Test Circuit**

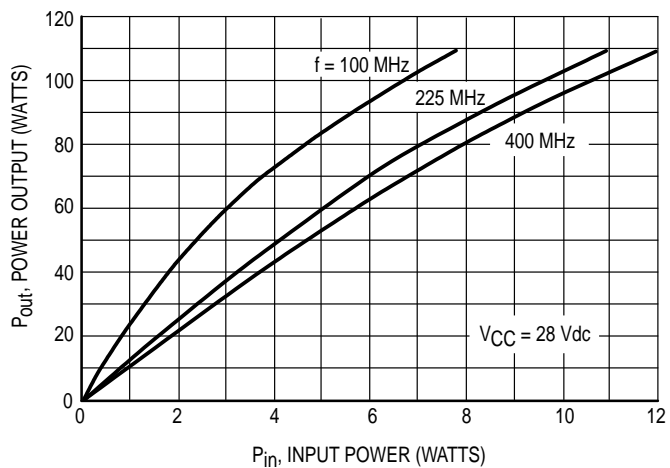


Figure 2. Output Power versus Input Power

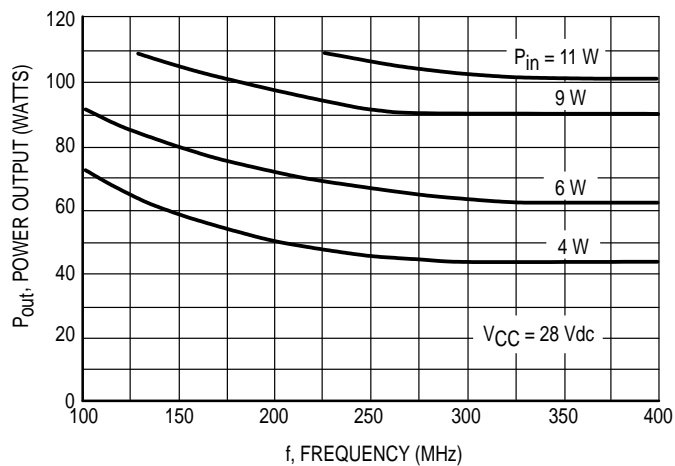


Figure 3. Output Power versus Frequency

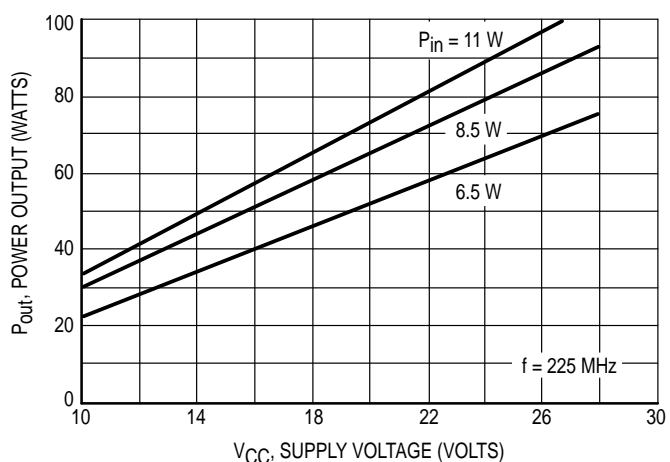


Figure 4. Output Power versus Supply Voltage

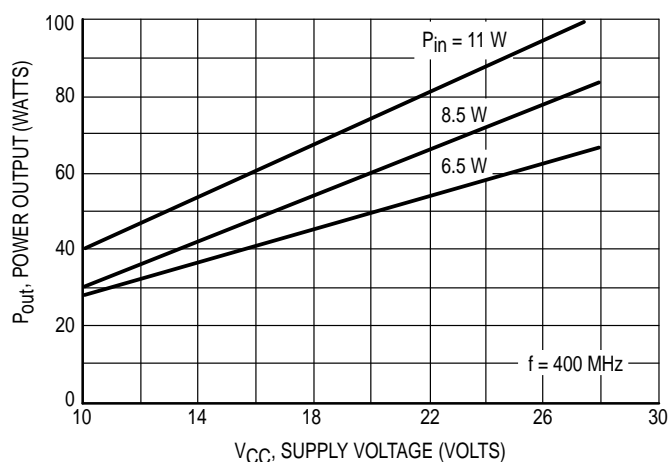


Figure 5. Output Power versus Supply Voltage

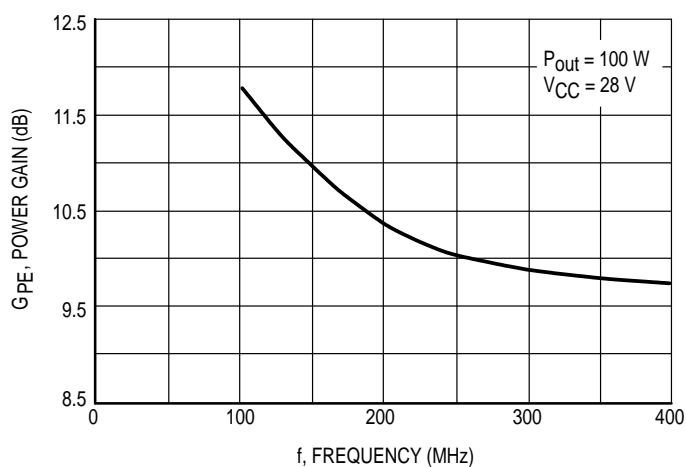
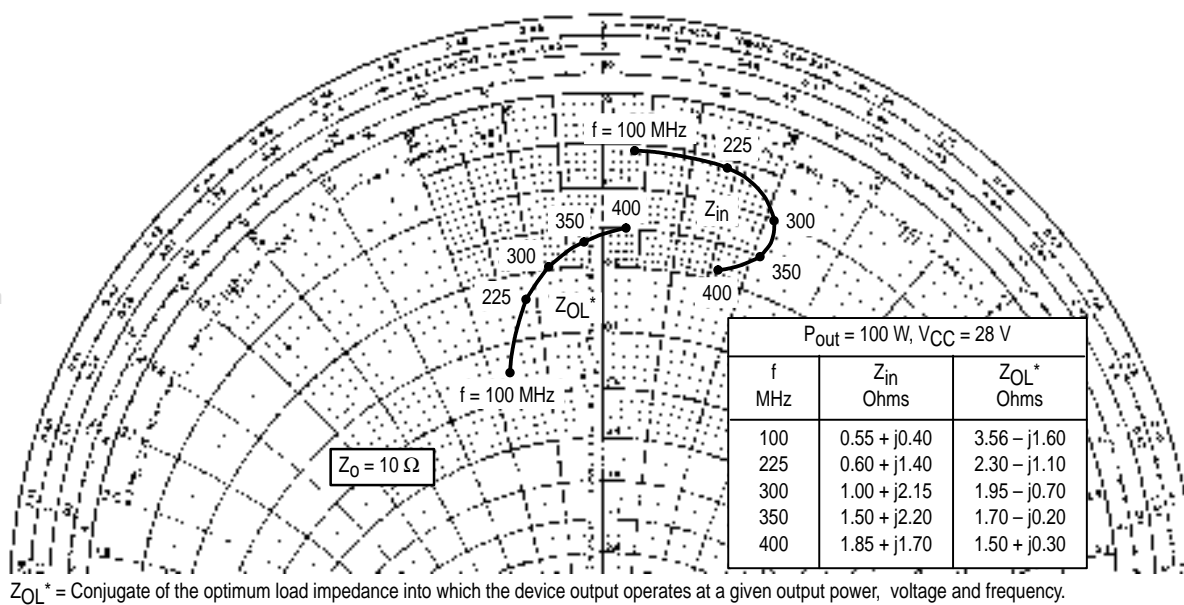
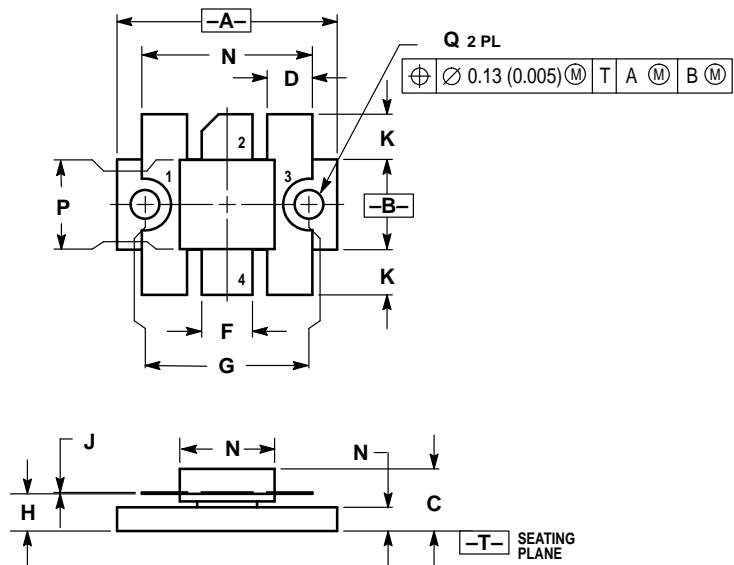


Figure 6. Power Gain versus Frequency



**Figure 7. Series Equivalent Input/Output Impedance**

PACKAGE DIMENSIONS




- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.965	0.985	24.51	25.02
B	0.390	0.410	9.91	10.41
C	0.250	0.290	6.73	7.36
D	0.190	0.210	4.83	5.33
E	0.095	0.115	2.42	2.92
F	0.215	0.235	5.47	5.96
G	0.725	BSC	18.42	BSC
H	0.155	0.175	3.94	4.44
J	0.004	0.006	0.10	0.15
K	0.195	0.205	4.95	5.21
L	0.740	0.770	18.80	19.55
N	0.415	0.425	10.54	10.80
P	0.390	0.400	9.91	10.16
Q	0.120	0.135	3.05	3.42

- STYLE 1:
- PIN 1: EMITTER
2. COLLECTOR
3. EMITTER
4. BASE

CASE 333-04  
ISSUE E

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